

Assam Electronics Development Corporation Ltd. (AMTRON)
Industrial Estate, Bamunimaidan, Guwahati - 781021
NOTICE INVITING TENDER ENQUIRY

Ref No. AEDC/SDC/2025-26/20

Dated- 05/02/2026

Assam Electronics Development Corporation Ltd (AMTRON) invites bids from Original Equipment Manufacturer (OEM) or its authorized dealers/partner/reseller for “Augmentation of Storage Solution Phase II” having technical specification as detailed below in relevant section. Submission of bids shall be online and to be submitted through <https://assamtenders.gov.in>

1.1.1 SCHEDULE OF TENDER

Tender No.	AEDC/SDC/2025-26/20
Scope of Work	Supply, installation & commissioning of items specified in this tender with 5 (five) years onsite comprehensive warranty.
Name of the tender issuer	Assam Electronics Development Corporation Ltd.
Date of issue of tender document	05/02/2026
Last Date for Submission of Bids	Signed copy of the Tender and supporting documents to be submitted online on or before 01:00PM, 16/02/2026. Hard copy of only Power of Attorney to be submitted in the Drop Box available at MD Office, AMTRON by 01:00PM, 16/02/2026.
Date of Opening of Technical Bids	16/02/2026 at 02:30 PM.
Place of Submission & Opening of Bids	Conference room, MD Office, AMTRON
Address for Communication	Managing Director Assam Electronics Dev. Corporation Ltd., Industrial Estate, Bamunimaidan, Guwahati – 781021, Assam
Phone No. for Communication	+91-8638291361
e- mail ids	mdc@amtron.in

1.1.2. Tender Processing Fee:

A non-refundable fee of **Rs 4000/- (Rupees Four Thousand)** shall be made towards the cost of tender processing fee through Internet Banking from State Bank of India (SBI) or any other banks listed at SBMOPS on <https://assamtenders.gov.in> or NEFT/RTGS in case of offline payment from any Bank.

1.1.3 Bid Security/Earnest Money Deposit

The bid document must be accompanied by the Earnest Money Deposit of **Rs. 4,00,000.00 (Rupees Four Lakh Only)** through –

- i) Option 1- Internet Banking from State Bank of India (SBI) or any other banks listed at SBMOPS on <https://assamtenders.gov.in>
- ii) Option 2- In case of non-availability of Net Banking facility, Bidders may submit Tender Processing Fees and Bid Security using NEFT/RTGS option from any Bank against system generated prefilled challan. For details, please refer to -
<https://assamtenders.gov.in/nicgep/app?page=WebAnnouncements&service=page>
(OM Related to Online Tender Processing Fees and EMD)

PART I - TECHNICAL BID

1.2 Pre-Qualification Criteria:

SL. No.	Bidder/OEM Pre-Qualification Criteria	Supporting Documents	Checklist (Yes)
1	The Bidder can be a Company/Firm having its registered Office in India and Service Engineer posted in Bengaluru.	Certificate of Incorporation/Trade License to be provided. Biodata of Service Engineer to be provided with Phone number and email-ID.	
2	GST Registration and PAN Card to be furnished.	Relevant document to be submitted	
3	Bid Security/EMD and Tender Processing Fee (Mandatory)	Reference to be submitted in Form D	
4	Power of Attorney to the authorized signatory of the bidder to sign the bid document, if it is a company/Partnership Firm.	As per format mentioned in Form I. (Hard Copy should be submitted)	
5	Profile of Company	As per format mentioned in Form C.	
6	Bidder should not be blacklisted by any Government/PSU entity in last three years.	Undertaking from Bidder need to be provided.	
7	Bidder should have experience in supply and installation of Storage Solutions in last three years in PSU/Govt entities.	Relevant Work Order and completion certificate to be submitted.	
8	In case the bidder is not an OEM, authorization letter form OEM should be provided as proof of eligibility. The bidders must be an authorized dealer/partner/reseller of the OEM.	OEM undertaking or as per format mentioned in Performa A or as per OEM Format.	
9	OEM should provide an undertaking that the bidder quoting their products will supply the items within 45 days.	Undertaking from OEM to be submitted without which bid will be rejected.	
10	Replacement of all components and subcomponents -should be covered under warranty -shipping cost for such replacements will be borne by the OEM. - unmounting and packing of faulty components will be the responsibility of the OEM. - unpacking and mounting of new components will be the responsibility of the OEM. -no extra cost will be borne by buyer for replacement and shipping.	Undertaking from OEM to be submitted without which bid will be rejected.	
11	Declaration regarding acceptance of Terms & Condition contained in the tender document.	As per format mentioned in Performa B	
12	OEM should not be blacklisted by any Government/PSU entity in last five years.	OEM undertaking to be submitted.	
13	Spare parts to be made available by OEM within 7 business days from the date of call log.	OEM undertaking with Warehouse details	

SL. No.	Bidder/OEM Pre-Qualification Criteria	Supporting Documents	Checklist (Yes)
14	Proposed product and its constituent sub-components should not be declared as end of support by next 5 years.	OEM undertaking to be submitted.	
15	OEM to provide complete escalation matrix for after sales warranty and services.	Escalation Matrix in OEM letterhead to be submitted	
16	The bidder should submit an undertaking that during the entire project period one Service Engineer will be available or posted at Bengaluru for same business day support and maintenance for entire project duration. Cost for the same if applicable should be borne by the bidder. Necessary SLA will be applicable during tenure of the project.	Bidder's Undertaking and Acceptance to the SLA in Annexure	
17	Restrictions rules imposed by Govt. of India for procurement from bidders from countries that share land borders with India will be applicable.	Undertaking from OEM & Bidder in support of the same.	
18	The Bill of Material mentioned in Clause 1.3.1 is tentative. The proposed solution should complete and no additional item/license is required for the scale up.	<Undertaking from OEM to be submitted>	
19	All materials should be supplied with 5 (five) years advanced hardware replacement warranty and onsite support.	OEM Undertaking to be submitted	
20	Unpriced, complete and correct Bill of Material including part codes of components, sub-components, service, warranty, licenses, subscription along with quantities to be submitted along with the bid, without which Bid will be rejected. No clarification/correction will be sought post submission of bid.	OEM Undertaking to be submitted for the proposed bill of materials.	

1.3 Scope of work:

Supply: The bidder should supply, install & commission the items as per the Bill of Materials (BOM) below. All goods need to be supplied F.O.R. Bengaluru.

1.3.1 Bill of Material: Augmentation of NetApp AFF-C800 Storage Solution to additional 500TB

Product	Qty
Drive Pack,NVMe,SED,CF,2X30.7TB,AD,-C	To be mentioned by the OEM. OEM must submit detailed architecture showing number of shelves, drives, RAID configuration, usable capacity calculation (post RAID, spare, overhead), and expansion headroom
Cable,100GbE,QSFP28-QSFP28,Cu,2m,-C	
Power Supply,1600W,Titanium,-C	
Rail,4-Post,Thin,Rnd/Sq-Hole,Sm,Adj,24-32,-C	
Jumper Crd,In-Cab,48-IN,C13-C14-C	
HBA,4-port FCP Targt-Init 32Gb PCIe w/SFP+	
SFP+ Optical,32Gb FC Shortwave	
NIC 2-Pt BareCage 100GbE RoCE QSFP28 PCIe	
Above list of items are tentative. Part Code and Description of all items to be proposed by the OEM to complete the solution. All ONTAP licenses, firmware updates, and controller software required for expansion shall be included for 5 years.	

1.3.2. Re-location of Existing Storage System

1.3.2.1. The existing NetApp AFF-C800 storage system currently installed at AMTRON premises shall be de-racked, safely packed, transported, re-installed, and made fully operational at the Bengaluru Disaster Recovery site by the selected bidder in co-ordination with the OEM.

1.3.2.2. The relocation shall be carried out without any data loss and with minimum possible service disruption.

1.3.2.3. The bidder/OEM shall be fully responsible for:

- Proper shutdown, labeling, dismantling and packing
- Transit insurance and safe transportation
- Insurance shall cover transit, loading/unloading, and installation risks until successful sign-off at DR site
- Reinstallation, re-cabling, and reconfiguration at DR site
- Validation of system health and data integrity post-relocation

1.3.2.4. A joint health check and sign-off report shall be submitted before proceeding with augmentation.

1.3.2.5. Any damage, data corruption, hardware failure, or configuration loss occurring during relocation shall be fully rectified by the bidder/OEM at no additional cost to AMTRON.

1.3.2.6. After successful relocation and stabilization of the base system, the bidder shall perform the proposed capacity augmentation in a non-disruptive manner without affecting existing workloads or stored data.

1.3.2.7. The augmentation activity shall commence only after submission of:

- OEM-certified system health report
- Disk, controller, and NVRAM status verification
- Cluster and ONTAP health validation

1.3.2.8. The bidder shall ensure proper backup verification prior to relocation and shall prepare a rollback plan in consultation with AMTRON.

1.3.2.9. The bidder/OEM shall be liable for restoration of services in case of any failure arising from improper handling during relocation or augmentation.

1.3.2.10. The bidder shall provide transit insurance covering full replacement value of the existing storage hardware during transportation from AMTRON site to Bengaluru DR site.

Sd/-

Date: **05-02-2026**

Guwahati

For further details and Tender Documents visit <https://assamtenders.gov.in>

Managing Director
AEDC Ltd. (AMTRON)